

## C0603T162J1GACTU

## Aliases (C0603T162J1GAC7867)

SMD COTS COG, Ceramic, 1600 pF, 5%, 100 VDC, COG, SMD, MLCC, COTS, Ultra-Stable, Low Loss, Class I, 0603



Click here for the 3D model.

Chip Size 0603   L 1.6mm +/-0.15mm   W 0.8mm +/-0.15mm   T 0.8mm +/-0.07mm   S 0.7mm MIN   B 0.35mm +/-0.15mm	Dimensions	
W 0.8mm +/-0.15mm   T 0.8mm +/-0.07mm   S 0.7mm MIN	Chip Size	0603
T 0.8mm +/-0.07mm   S 0.7mm MIN	L	1.6mm +/-0.15mm
S 0.7mm MIN	W	0.8mm +/-0.15mm
	Т	0.8mm +/-0.07mm
B 0.35mm +/-0.15mm	S	0.7mm MIN
	В	0.35mm +/-0.15mm

Packaging Specifications	
Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	4000

General Information	
Series	SMD COTS COG
Style	SMD Chip
Description	SMD, MLCC, COTS, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
Failure Rate	Testing per MIL-PRF-55681 PDA 8%
AEC-Q200	No
Component Weight	3.7 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	1600 pF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	5%
Voltage DC	100 VDC
Dielectric Withstanding Voltage	250 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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